

**PATENT ASSIGNMENT**

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
<b>CONVEYING PARTY DATA</b>											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Masami Ochiai</td> <td>09/22/2010</td> </tr> <tr> <td>Tatsuya Makino</td> <td>09/22/2010</td> </tr> <tr> <td>Toshihiko Takasaki</td> <td>09/22/2010</td> </tr> <tr> <td>Atsushi Takahashi</td> <td>09/22/2010</td> </tr> </tbody> </table>		Name	Execution Date	Masami Ochiai	09/22/2010	Tatsuya Makino	09/22/2010	Toshihiko Takasaki	09/22/2010	Atsushi Takahashi	09/22/2010
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<b>RECEIVING PARTY DATA</b>											
Name:	HITACHI CHEMICAL COMPANY, LTD.										
Street Address:	1-1, Nishi-Shinjuku 2-chome										
Internal Address:	Shinjuku-ku										
City:	Tokyo										
State/Country:	JAPAN										
Postal Code:	1630449										
<b>PROPERTY NUMBERS Total: 1</b>											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12864341</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12864341						
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Application Number:	12864341										
<b>CORRESPONDENCE DATA</b>											
Fax Number:	(703)312-6666										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
Phone:	703-312-6600										
Email:	rperez@antonelli.com										
Correspondent Name:	ANTONELLI, TERRY, STOUT & KRAUS, LLP										
Address Line 1:	1300 NORTH SEVENTEENTH STREET										
Address Line 2:	SUITE 1800										
Address Line 4:	ARLINGTON, VIRGINIA 22209-3873										
ATTORNEY DOCKET NUMBER:	396.50833X00										
NAME OF SUBMITTER:	William I. Solomon										

OP \$40.00 12864341

Total Attachments: 1  
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# ASSIGNMENT

ATTY. DOCKET NO.:

396.50833X00

WHEREAS the below named inventor (if only one inventor is named below) or inventors (if plural inventors are named below) hereinafter referred to as the ASSIGNOR invented a certain improvement relating to

**RESIN COMPOSITION FOR PRODUCTION OF CLAD LAYER, RESIN FILM FOR PRODUCTION OF CLAD LAYER UTILIZING THE RESIN COMPOSITION, AND OPTICAL WAVEGUIDE AND OPTICAL MODULE EACH UTILIZING THE RESIN COMPOSITION OR THE RESIN FILM**

for which an application for Letters Patent to be filed in the United States Patent and Trademark Office was executed on even date.

for which U.S. Application No. \_\_\_\_\_ for Letters Patent was filed in the U.S. Patent and Trademark Office on \_\_\_\_\_

for which an International Application was filed on **January 23, 2009** as **PCT/JP2009/051050**, designating the United States.

**AND WHEREAS**  
**HITACHI CHEMICAL COMPANY, LTD.**  
**1-1, Nishi-Shinjuku 2-chome, Shinjuku-ku,**  
**Tokyo 1630449 Japan**

hereinafter referred to as the ASSIGNEE, is desirous of acquiring the entire right, title, and interest in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations and extensions thereof.

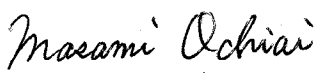



NOW, WITNESSETH that for good and valuable consideration, the receipt whereof is hereby acknowledged, ASSIGNOR hereby assigns, sells, and transfers to ASSIGNEE, its assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor, including any and all renewals, reissues, reexaminations and extensions thereof, and in and to any and all priority and/or convention rights or benefits accruing or to accrue with respect to the filing or securing of patents in the United States and/or any countries foreign thereto, SAID ASSIGNEE, its assigns and legal representatives to have, hold, exercise, and enjoy said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor, including any and all renewals, reissues, reexaminations and extensions thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, reexaminations and extensions thereof, for the use and benefit of ASSIGNEE and its assigns and legal representatives, in as ample and beneficial a manner to all intents and purposes as the ASSIGNOR might or could have held and enjoyed the same, if the assignment had not been made.

AND ASSIGNOR hereby agrees to execute all papers that may be necessary to file applications in the United States and foreign countries for said invention and to assign the same to said ASSIGNEE, its assigns and legal representatives and to execute any other papers that may be needed in connection with filing said applications and securing Letters Patents thereon.

AND ASSIGNOR authorizes and requests the Commissioner of Patents and Trademarks to issue a Letters Patent on said application, and on any and all divisions and continuations thereof, to ASSIGNEE, its assigns and legal representatives, in accordance herewith.

The undersigned hereby grant(s) the law firm of Antonelli, Terry, Stout, Kraus, LLP the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

IN TESTIMONY WHEREOF this assignment is executed by ASSIGNOR.

201	FULL NAME OF SOLE OR FIRST NAMED INVENTOR	INVENTOR'S SIGNATURE	DATE
	<b>Masami OCHIAI</b>		<b>SEP. 22. 2010</b>
202	FULL NAME OF SECOND JOINT INVENTOR	INVENTOR'S SIGNATURE	DATE
	<b>Tatsuya MAKINO</b>		<b>SEP. 22. 2010</b>
203	FULL NAME OF THIRD JOINT INVENTOR	INVENTOR'S SIGNATURE	DATE
	<b>Toshihiko TAKASAKI</b>		<b>SEP. 22. 2010</b>
204	FULL NAME OF FOURTH JOINT INVENTOR	INVENTOR'S SIGNATURE	DATE
	<b>Atsushi TAKAHASHI</b>		<b>SEP. 22. 2010</b>
205	FULL NAME OF FIFTH JOINT INVENTOR	INVENTOR'S SIGNATURE	DATE
206	FULL NAME OF SIXTH JOINT INVENTOR	INVENTOR'S SIGNATURE	DATE

**PATENT**

**RECORDED: 10/19/2010**

**REEL: 025160 FRAME: 0836**